



**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES

Part Number: AAA3528RGBS/K11/C8CC

Hyper Red  
Green  
Blue

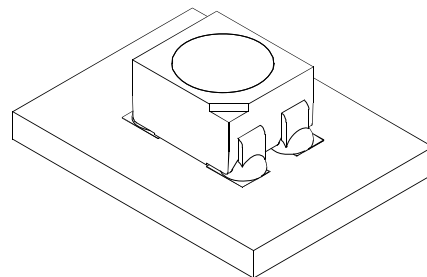
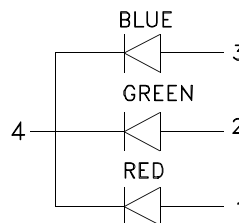
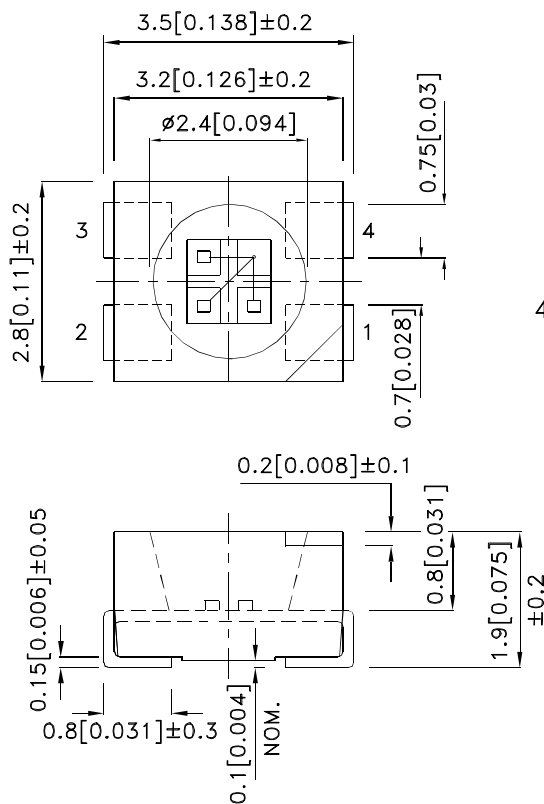
### Features

- Suitable for all SMD assembly and solder process.
- Available on tape and reel.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN Light Emitting Diode.
- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

### Package Dimensions



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

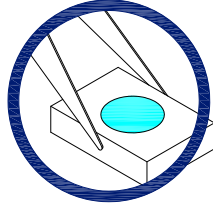


## Handling Precautions

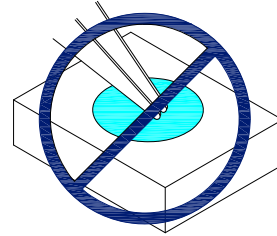
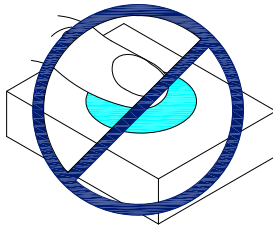
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly Orangeuces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

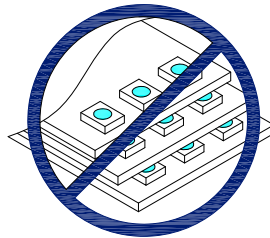
1. Handle the component along the side surfaces by using forceps or appropriate tools.



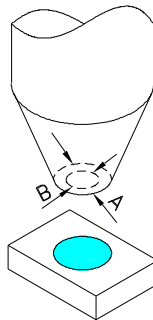
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

## Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Max.	2θ1/2
AAA3528RGBS/K11/C8CC	Hyper Red (AlGaInP)	Water Clear	400	1000	120°
	Green (InGaN)		1000	2300	
	Blue (InGaN)		200	500	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Min.	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue		640 520 465		nm	If=20mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	610 520 463		635 535 473	nm	If=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue		20 35 22		nm	If=20mA
C	Capacitance	Hyper Red Green Blue		27 100 100		pF	Vf=0V;f=1MHz
Vf [2]	Forward Voltage	Hyper Red Green Blue		2.2 3.2 3.3	2.8 4 4	V	If=20mA
IR	Reverse Current	Hyper Red Green Blue			10 50 50	uA	VR=5V

Notes:

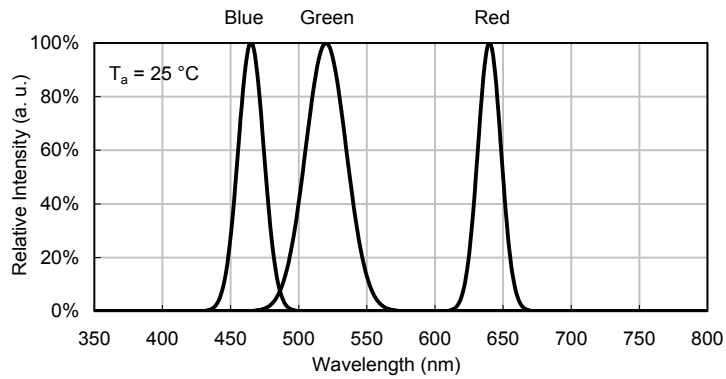
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3.Wavelength value is traceable to CIE127-2007 standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

## Absolute Maximum Ratings at TA=25°C

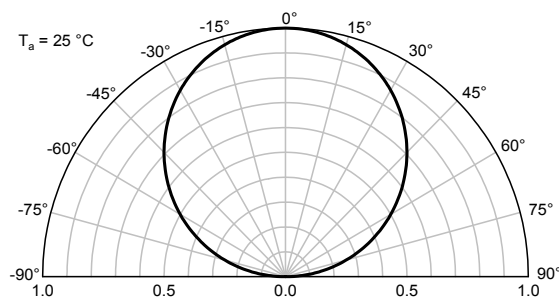
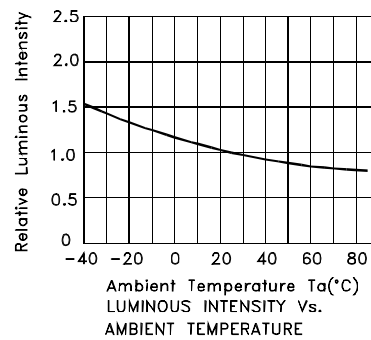
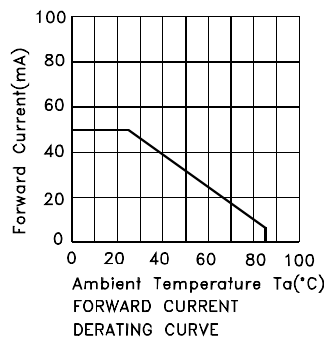
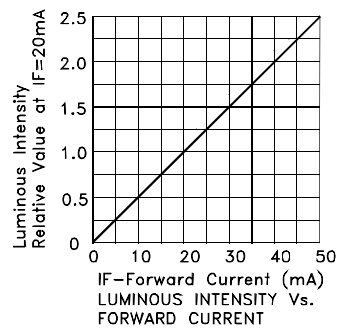
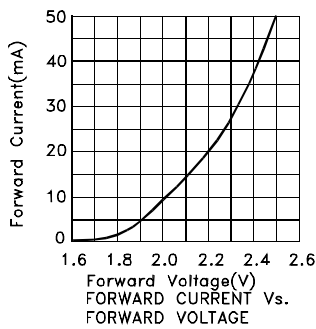
Parameter	Hyper Red	Green	Blue	Units
Power dissipation	140	120	120	mW
DC Forward Current	50	30	30	mA
Peak Forward Current [1]	150	100	100	mA
Electrostatic Discharge Threshold (HBM)	3000	450	250	V
Reverse Voltage	5			V
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Notes:

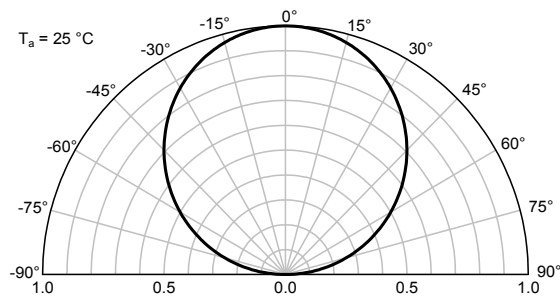
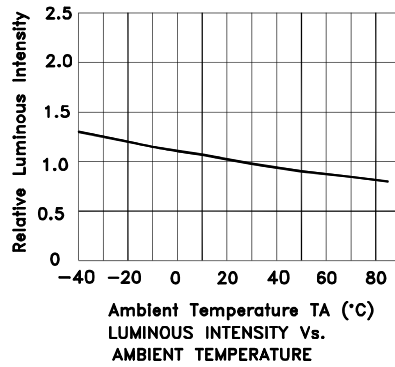
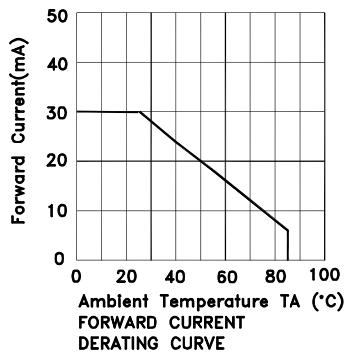
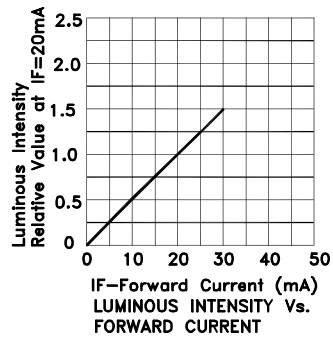
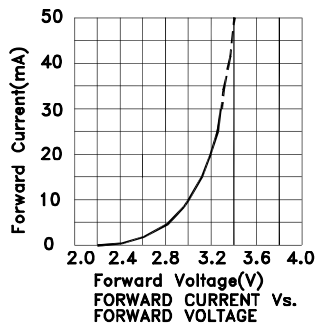
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



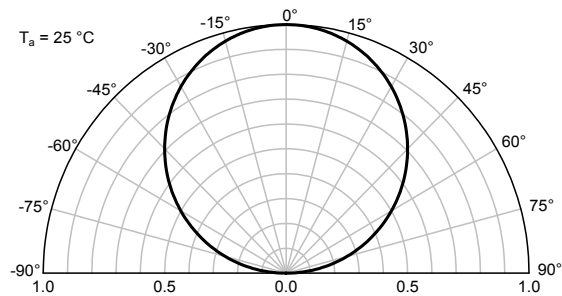
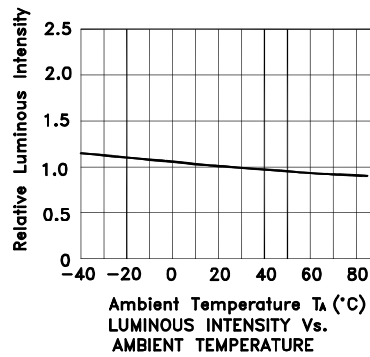
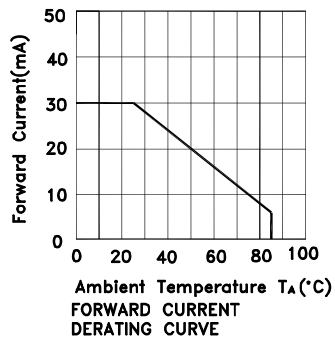
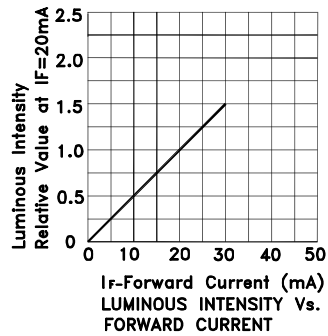
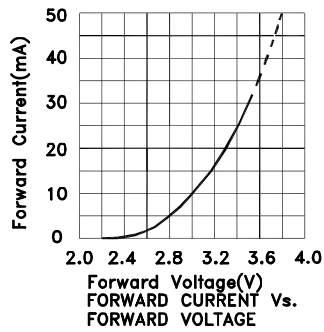
## AAA3528RGBs/K11/C8CC Hyper Red



## Green

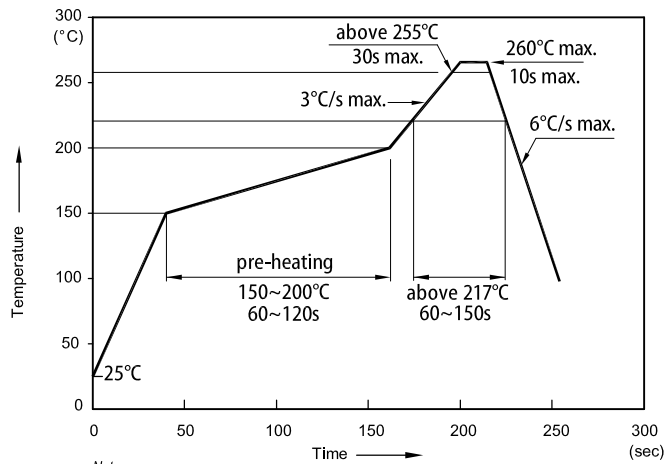


## Blue



## AAA3528RGBS/K11/C8CC

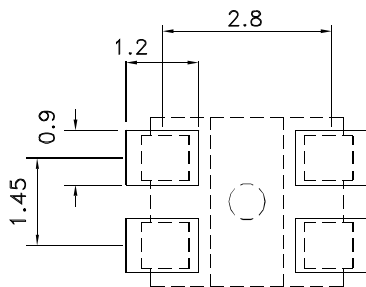
Reflow Soldering Profile for Lead-free SMD Process



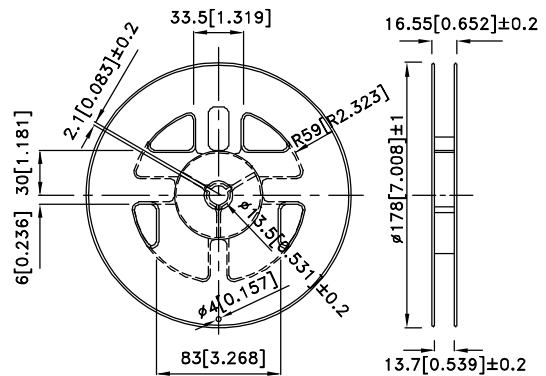
Notes:

1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

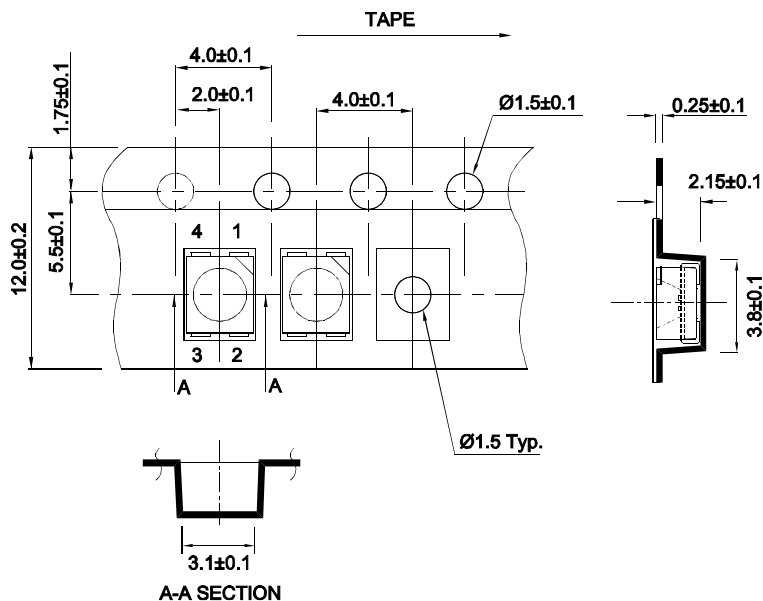
### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



### Reel Dimension

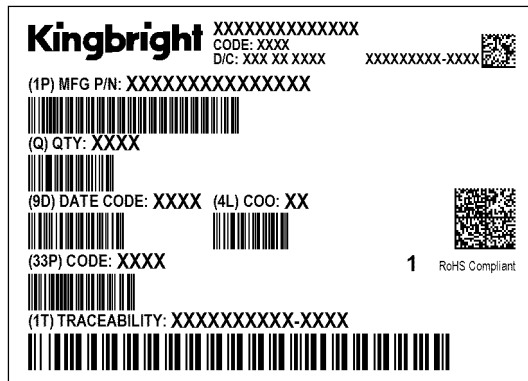
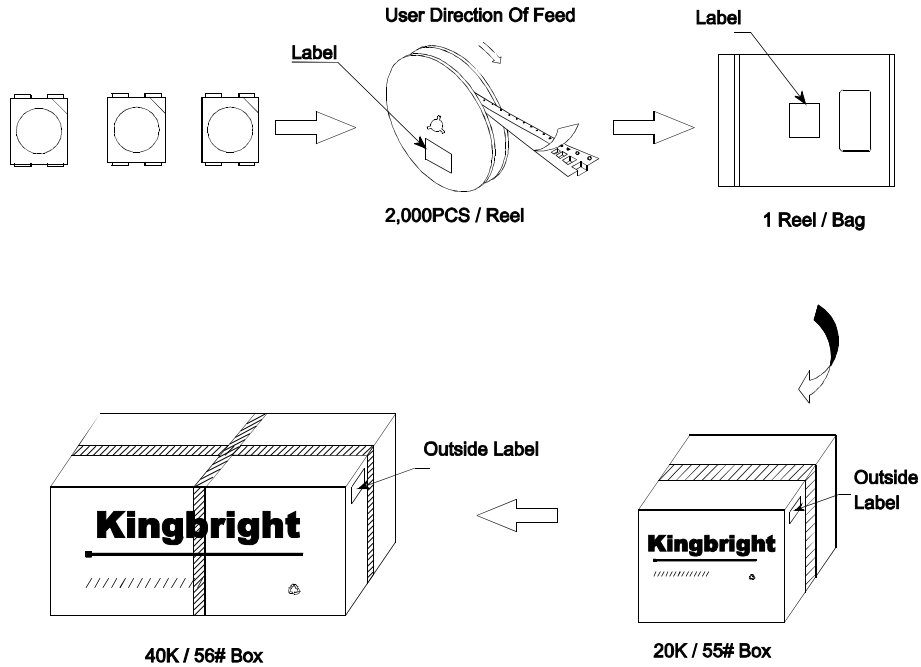


### Tape Dimensions (Units : mm)



## PACKING & LABEL SPECIFICATIONS

AAA3528RGB/K11/C8CC



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